A common need of any system is controlling multiple devices through digital logic. Systems continue to move to lower voltage nodes for power savings. With this trend, using devices that are not natively compatible with the control logic of the system can lead to extra system costs through board size and BOM count. Also, the use of more components in the design of the system creates more opportunities for power sequencing issues. Using devices that have integrated support for the control logic of the system achieves a cost effective solution.

To prevent digital logic control issues, the system must ensure that the output high (\(V_{OH}\)) logic output is higher than the input high (\(V_{IH}\)) logic input it is controlling. In addition, the output low (\(V_{OL}\)) of the logic output must be lower than the input low (\(V_{IL}\)) of the logic input it is controlling. See Figure 1 for this logic standard. Some components may not meet the standard, but having \(V_{IH} < V_{OH}\) and \(V_{IL} > V_{OL}\) ensures proper system operation.

If a processor on a 1.8 V voltage rail is controlling a signal switch with a supply rail of 3.3 V without integrated 1.8 V logic capability, the system is required to use an external translator as shown in Figure 2 or a translator. The voltage domain translation is necessary because the \(V_{IH}\) for a 3.3 V device is higher than the \(V_{OH}\) of a 1.8 V processor that is controlling the device.

Example Application

In Figure 3, an 8 to 1 MUX expands the sensors being sampled by an ADC. Without 1.8 V logic, a 12 pin (4 bit) translator is required in between the processor and the MUX. By adding a 4 bit translator to an 8:1 MUX the board area for the MUX is increased by more than 25%.
By choosing a device with integrated 1.8 V logic, the discrete components can be removed, see Figure 4. This leads to a direct connection of the logic control from the processor to the device even with a supply domain mismatch. Not only does this remove component cost and board space, any supply sequencing requirements associated with the translator are also removed from the system operation requirements.

Figure 4. MUX/Switch With Integrated 1.8 V Logic

Different Forms of 1.8 V Logic and Their Tradeoffs

With 1.8 V logic there are different implementations with their own benefits and drawbacks. When the input to a typical CMOS logic buffer is not at the supply rail, a shoot through current can be observed from the device supply to ground. This is due to both transistors being partially on creating a path to ground, with an increase in $I_{CC}$ as shown in Figure 5. An example device is the TS5A2066 that has an input thresholds of 70% of $V_{CC}$ for $V_{IH}$ and 30% of $V_{CC}$ for $V_{IL}$ and is not 1.8 V logic compatible.

Figure 5. 70%/30% Threshold $I_{CC}$ Vs Logic Input Voltage

1.8 V Compatible logic Inputs

With the proper implementation, 1.8 V compatible inputs can be achieved while minimizing the shoot through current observed in a standard CMOS buffer input. In Figure 6, the shoot through current is remains low compared to the TS5A2066 while still operating from a 3.3 V supply. When the input voltage is at the supply rails, the $I_{CC}$ is minimal. With this approach the external translator is no longer needed and the $I_{CC}$ is maintained.

Figure 6. 1.8 V Compatible $I_{CC}$ Vs Logic Input Voltage

Fixed Logic Thresholds

The TMUX136 is a high-speed 2:1 MUX that supports fixed thresholds across the supply range for 1.8 V logic inputs. This method has little to no change in $I_{CC}$ with change in logic input voltage as shown in Figure 7. The static current consumption with this device will be higher as a trade-off.

Figure 7. Fixed Threshold $I_{CC}$ Vs Logic Input Voltage

Logic Supply Input Pin

Another approach is to use the TS5A26542 with an input logic supply pin ($V_{IO}$) to set the desired voltage of the input logic. Because the logic buffer is supplied by a rail that matches the input voltage, there is no shoot through current from the VCC pin as shown in Figure 8 even with a 3.3 V supply (The $I_{CC}$ for this measurement is in 10-20 nA range). There is a small shoot through current from the logic supply pin, but it is minimal. The trade-off is an extra pin is required to achieve this functionality.
Figure 8. Separate Logic Supply Pin $I_{CC}$ Vs Logic Input Voltage

Table 1. Alternative Device Recommendations

<table>
<thead>
<tr>
<th>Device</th>
<th>Configuration</th>
<th>Key Features</th>
</tr>
</thead>
<tbody>
<tr>
<td>TMUX1574</td>
<td>4-channel 2:1</td>
<td>Powered-off protection, Low Con (7.5pF), Low Ron (2Ω), Wide bandwidth (2GHz), 1.8V Logic Compatible</td>
</tr>
<tr>
<td>TMUX1575</td>
<td>4-channel 2:1</td>
<td>1.3 mm x 1.3 mm package, 1.2-V compatible control inputs, Powered-off protection, Low Con (10 pF), Low Ron (1.7 Ω), 1.8 GHz Bandwidth.</td>
</tr>
<tr>
<td>TMUX1511</td>
<td>4-channel 1:1</td>
<td>Powered-off protection, Low Con (3.3pF), Low Ron (2Ω), Wide bandwidth (3GHz), 1.8V Logic Compatible</td>
</tr>
<tr>
<td>TS3A27518E</td>
<td>6-channel 2:1</td>
<td>Powered-off protection, 1.8-V compatible control inputs</td>
</tr>
<tr>
<td>TMUX1308</td>
<td>1-channel 8:1</td>
<td>1.8-V compatible control inputs, Injection current control</td>
</tr>
</tbody>
</table>

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